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TTM Technologies, Inc. Receives Nadcap Accreditation at Its Hong Kong Site for Aerospace Quality

First TTM Asia Pacific Site to Earn the Nadcap Certificate

SANTA ANA, Calif., March 3, 2011 (GLOBE NEWSWIRE) -- TTM Technologies, Inc. (Nasdaq:TTMI) announced that its high mix, low volume and QTA facility in Hong Kong ("OPCM") has attained Nadcap accreditation for electronics manufactured for the aerospace industry. This is the first TTM Asia Pacific site to be certified. This accreditation signifies commitment to continual improvement in aerospace quality by fulfilling customer requirements and industry specifications.

Kent Alder, President and CEO of TTM, noted, "Our team in Hong Kong has worked hard to understand the essence of Nadcap requirements and perfect our processing systems with better reliability and traceability. We are pleased with this achievement as it is indeed an important milestone for us. This means we can now better serve the needs of our aerospace customers as well as the growing local aerospace industry." Alder concluded, "We will continue to expand our capabilities to service the aerospace industry globally."

With this recent accomplishment, TTM has three facilities in North America with AS9100 and Nadcap certifications and two Asia Pacific facilities certified with AS9100, one of them with Nadcap accreditation.

"Achieving Nadcap accreditation is not easy: it is one of the ways in which the aerospace industry identifies those who excel at manufacturing quality product through superior special processes. Companies such as OPCM work hard to obtain this status and they should be justifiably proud of it," said Joe Pinto, Vice President and Chief Operating Officer at the Performance Review Institute. "PRI is proud to support continual improvement in the aerospace industry by helping companies such as OPCM be successful and we look forward to continuing to assist the industry moving forward."

Safe Harbor Statement

This release contains forward-looking statements that relate to future events or performance. These statements reflect the company's current expectations, and the company does not undertake to update or revise these forward-looking statements, even if experience or future changes make it clear that any projected results expressed or implied in this or other company statements will not be realized. Furthermore, readers are cautioned that these statements involve risks and uncertainties, many of which are beyond the company's control, which could cause actual results to differ materially from the forward-looking statements. These risks and uncertainties include, but are not limited to, the company's dependence upon the electronics industry, the impact of the current economic crisis, the company's dependence upon a small number of customers, the unpredictability of and potential

fluctuation in future revenues and operating results, increased competition from low-cost foreign manufacturers and other "Risk Factors" set forth in the company's most recent SEC filings.

About TTM Technologies, Inc.

TTM Technologies, Inc. is a major global printed circuit board manufacturer, focusing on quick-turn and technologically advanced PCBs and the backplane and sub-system assembly business. TTM stands for time-to-market, representing how the company's time-critical, one-stop manufacturing services enable customers to shorten the time required to develop new products and bring them to market. Additional information can be found at www.ttmtech.com.

The TTM Technologies logo is available at <https://www.globenewswire.com/newsroom/prs/?pkgid=5691>

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